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N-Channel PowerTrench[®] SyncFETTM 30 V, 49 A, 3.5 m Ω

Features

- Max $r_{DS(on)} = 3.5 \text{ m}\Omega \text{ at } V_{GS} = 10 \text{ V}, I_D = 21 \text{ A}$
- Max $r_{DS(on)} = 4.3 \text{ m}\Omega$ at $V_{GS} = 4.5 \text{ V}$, $I_D = 19 \text{ A}$
- Advanced package and silicon combination for low r_{DS(on)} and high efficiency
- SyncFETTM Schottky Body Diode
- MSL1 Robust Package Design
- 100% UIL tested
- RoHS Compliant

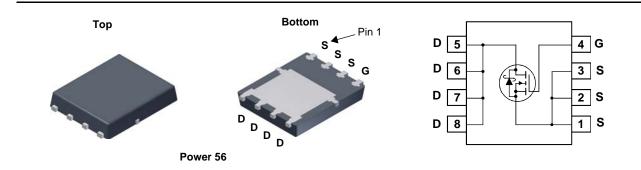


General Description

The FDMS0309AS has been designed to minimize losses in power conversion application. Advancements in both silicon and package technologies have been combined to offer the lowest $r_{\text{DS}(on)}$ while maintaining excellent switching performance.This device has the added benefit of an efficient monolithic Schottky body diode.

Applications

- Synchronous Rectifier for DC/DC Converters
- Notebook Vcore/GPU Low Side Switch
- Networking Point of Load Low Side Switch
- Telecom Secondary Side Rectification



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			30	V	
V _{DSt}	Drain to Source Transient Voltage (tTransient < 100 ns)			33	V	
V _{GS}	Gate to Source Voltage		(Note 4)	±20	V	
	Drain Current -Continuous (Package limited)	T _C = 25°C		49	A	
,	-Continuous (Silicon limited)	T _C = 25°C		96		
D	-Continuous	$T_A = 25^{\circ}C$	(Note 1a)	21	A	
	-Pulsed			100		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	66	mJ	
Р	Power Dissipation $T_{\rm C} = 25^{\circ}{\rm C}$			50	w	
P _D	Power Dissipation	$T_A = 25^{\circ}C$	(Note 1a)	2.5	vv	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

R_{θJC} Thermal Resistance, Junction to Case 2.5 R_{θJA} Thermal Resistance, Junction to Ambient (Note 1a) 50

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity	
FDMS0309AS	FDMS0309AS	Power 56	13 "	12 mm	3000 units	

FDMS0309AS
N-Channel
PowerTrench [®]
SyncFET TM

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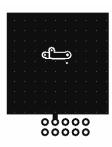
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 1 mA, V _{GS} = 0 V	30			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 10$ mA, referenced to 25 °C		25		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 24 V, V_{GS} = 0 V$			500	μA
I _{GSS}	Gate to Source Leakage Current, Forward	$V_{GS} = 20 V, V_{DS} = 0 V$			100	nA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 1 \text{ mA}$	1.2	1.6	3.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 10$ mA, referenced to 25 °C		-5		mV/°C
	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 21 A		2.7	3.5	
r _{DS(on)}		V _{GS} = 4.5 V, I _D = 19 A		3.4	4.3	mΩ
		$V_{GS} = 10 V, I_D = 21 A,$ T _J = 125 °C		3.7	4.8	- 1115.2
9 _{FS}	Forward Transconductance	$V_{DS} = 5 V, I_D = 21 A$		120		S
	-	*			1	
Dynamic	Characteristics					
•	Characteristics			2255	3000	pF
C _{iss}		$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V},$		2255 815	3000 1085	pF pF
C _{iss} C _{oss}	Input Capacitance	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz				
C _{iss}	Input Capacitance Output Capacitance			815	1085	pF
C _{iss} C _{oss} C _{rss} R _g	Input Capacitance Output Capacitance Reverse Transfer Capacitance			815 85	1085 125	pF pF
C _{iss} C _{oss} C _{rss} R _g Switching	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance			815 85	1085 125	pF pF
C _{iss} C _{oss} C _{rss} R _g	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance Characteristics			815 85 1.0	1085 125 2.5	pF pF Ω
	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance Characteristics Turn-On Delay Time	f = 1 MHz		815 85 1.0 11	1085 125 2.5 19	pF pF Ω ns
$\frac{C_{iss}}{C_{oss}}$ $\frac{C_{rss}}{R_g}$ Switching $\frac{t_{d(on)}}{t_r}$	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time Rise Time	f = 1 MHz V _{DD} = 15 V, I _D = 21 A,		815 85 1.0 11 4.5	1085 125 2.5 19 10	pF pF Ω ns ns
$\begin{array}{c} C_{iss} \\ C_{oss} \\ C_{rss} \\ R_g \\ \hline \\ \textbf{Switching} \\ t_{d(on)} \\ t_r \\ t_{d(off)} \\ \end{array}$	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time	f = 1 MHz V _{DD} = 15 V, I _D = 21 A, V _{GS} = 10 V, R _{GEN} = 6 Ω		815 85 1.0 11 4.5 29	1085 125 2.5 19 10 46	pF pF Ω ns ns ns
$\begin{array}{c} C_{iss} \\ C_{oss} \\ C_{rss} \\ R_g \\ \hline \\ \textbf{Switching} \\ \hline \\ \textbf{t}_{d(on)} \\ t_r \\ \hline \\ t_{d(off)} \\ \hline \\ t_f \\ \hline \end{array}$	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time	f = 1 MHz V _{DD} = 15 V, I _D = 21 A, V _{GS} = 10 V, R _{GEN} = 6 Ω		815 85 1.0 11 4.5 29 3.7	1085 125 2.5 19 10 46 10	pF pF Ω ns ns ns
$\begin{array}{c} C_{iss} \\ C_{oss} \\ C_{rss} \\ R_g \\ \hline \\ \textbf{Switching} \\ \hline \\ \textbf{t}_{d(on)} \\ t_r \\ t_{d(off)} \\ t_f \\ \hline \\ \textbf{Q}_g \\ \end{array}$	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge	f = 1 MHz V _{DD} = 15 V, I _D = 21 A, V _{GS} = 10 V, R _{GEN} = 6 Ω		815 85 1.0 11 4.5 29 3.7 34	1085 125 2.5 19 10 46 10 47	pF pF Ω ns ns ns ns nc

Drain-Source Diode Characteristics

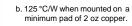
Electrical Characteristics T_J = 25 °C unless otherwise noted

V _{SD}	Source-Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2 A$ (Note 2)	0.6	0.8	V
	Source-Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 21 A$ (Note 2)	0.8	1.2	
t _{rr}	Reverse Recovery Time	I _F = 21 A, di/dt = 300 A/μs	26	42	ns
Q _{rr}	Reverse Recovery Charge	$I_F = 21$ A, di/dt = 300 A/µs	27	44	nC

Notes: 1. $R_{\theta,JA}$ is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. $R_{\theta,JC}$ is guaranteed by design while $R_{\theta,CA}$ is determined by the user's board design.

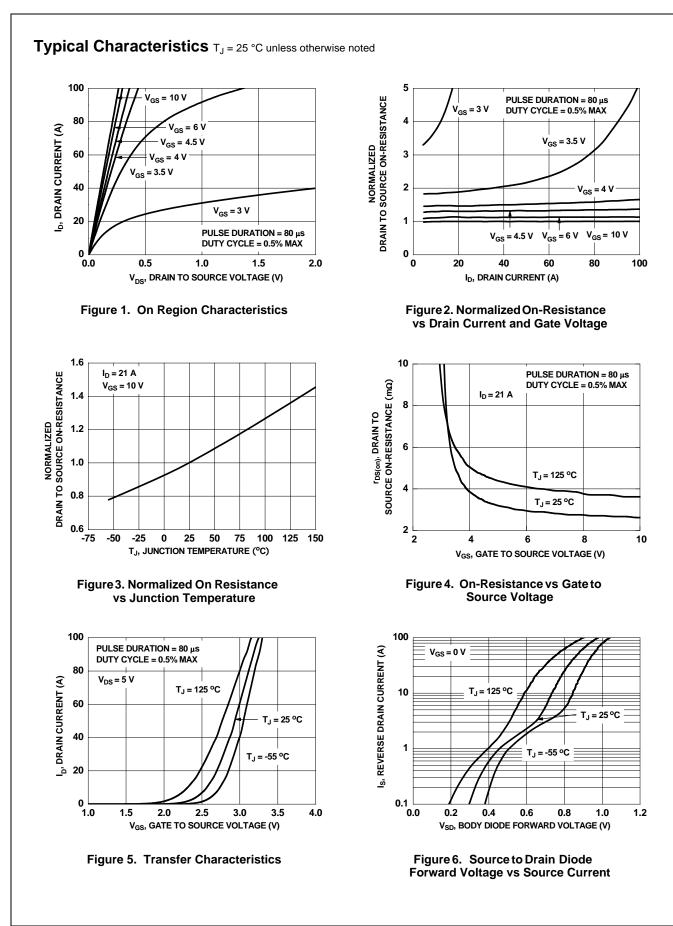


a. 50 °C/W when mounted on a 1 in² pad of 2 oz copper.

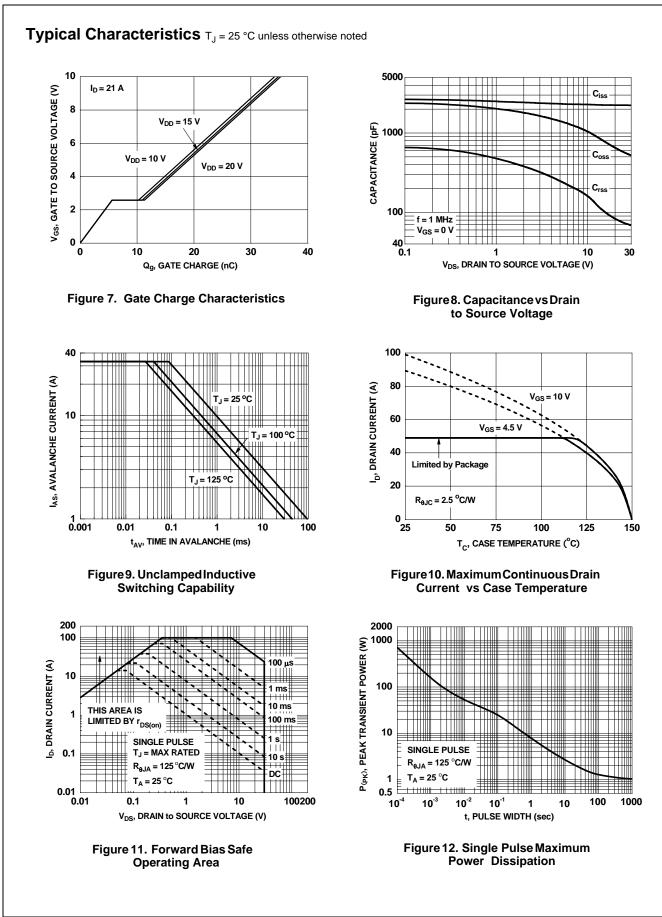


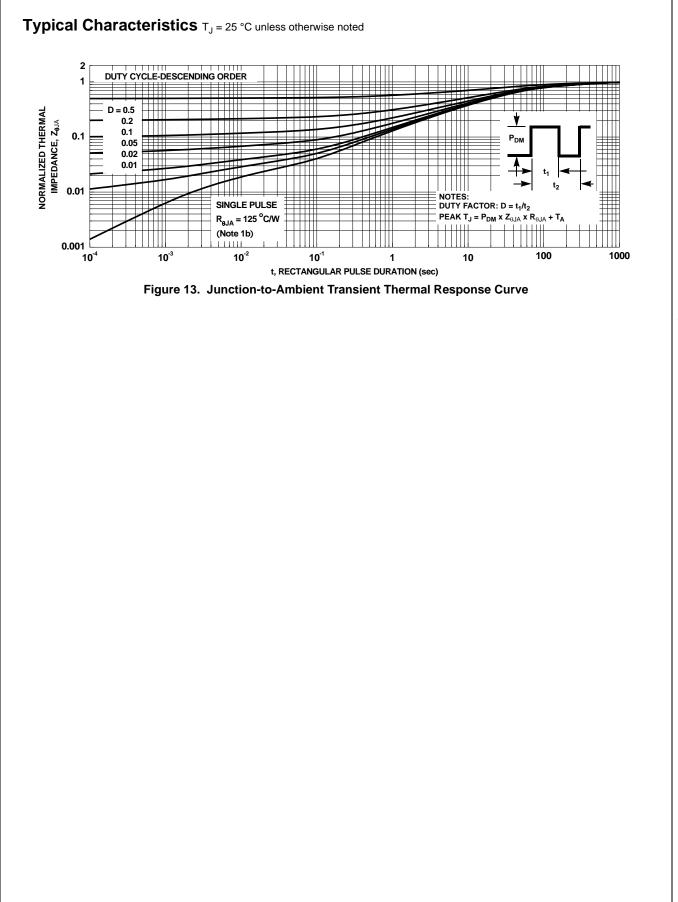


2. Pulse Test: Pulse Width < 300 μ s, Duty cycle < 2.0%. 3. E_{AS} of 66 mJ is based on starting T_J = 25 °C, L = 0.3 mH, I_{AS} = 21 A, V_{DD} = 27 V, V_{GS} = 10 V 4. As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied.









FDMS0309AS N-Channel PowerTrench[®] SyncFETTM

Typical Characteristics (continued)

SyncFET[™] Schottky body diode Characteristics

Fairchild's SyncFETTM process embeds a Schottky diode in parallel with PowerTrench MOSFET. This diode exhibits similar characteristics to a discrete external Schottky diode in parallel with a MOSFET. Figure 14 shows the reverse recovery characteristic of the FDMS0309AS.

Figure 14. FDMS0309AS SyncFET[™] body diode reverse recovery characteristic

Schottky barrier diodes exhibit significant leakage at high temperature and high reverse voltage. This will increase the power in the device.

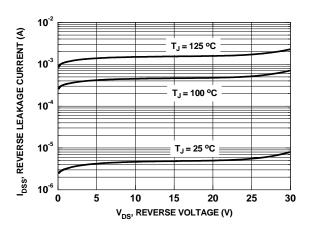


Figure 15. SyncFETTM body diode reverse leakage versus drain-source voltage

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